



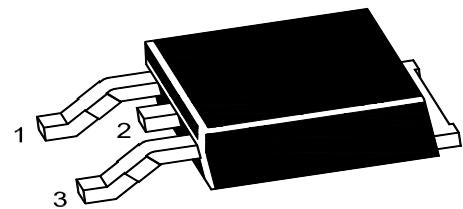
PJM30H09NTE

N-Channel Enhancement Mode Power MOSFET

Features

- Fast switching
- Low gate charge and $R_{DS(on)}$
- Low reverse transfer capacitances
- 100% single pulse avalanche energy test
- $V_{DS} = 300V, I_D = 9A$
- $R_{DS(on)} < 0.55\Omega @ V_{GS} = 10V$

TO-252

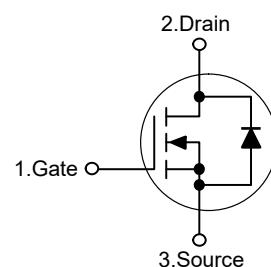


1. Gate 2.Drain 3.Source

Applications

- Power switch circuit of adaptor and charger.

Schematic Diagram



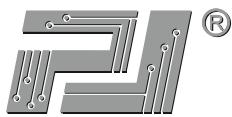
Absolute Maximum Ratings

Ratings at 25°C ambient temperature unless otherwise specified.

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	300	V
Gate-Source Voltage	V_{GS}	± 30	V
Drain Current-Continuous	I_D	9	A
Drain Current-Pulsed ^{Note1}	I_{DM}	36	A
Single pulse avalanche energy ^{Note4}	E_{AS}	420	mJ
Avalanche energy, Repetitive ^{Note1}	E_{AR}	9.8	mJ
Avalanche Current ^{Note1}	I_{AR}	9	A
Maximum Power Dissipation	P_D	55	W
Junction Temperature	T_J	150	°C
Storage Temperature Range	T_{STG}	-55 to +150	°C

Thermal Characteristics

Thermal Resistance, Junction-to-Ambient ^{Note2}	$R_{\theta JA}$	62.5	°C/W
Maximum Junction-to-Case ^{Note2}	$R_{\theta JC}$	2.28	°C/W



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Electrical Characteristics

(Ta=25°C unless otherwise specified)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =250μA	300	--	--	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =300V, V _{GS} =0V	--	--	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±30V, V _{DS} =0V	--	--	±100	nA
Gate Threshold Voltage ^{Note3}	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	2	--	4	V
Drain-Source On-Resistance ^{Note3}	R _{DS(on)}	V _{GS} =10V, I _D =4.5A	--	0.4	0.55	Ω
Forward Transconductance ^{Note3}	g _{FS}	V _{DS} =50V, I _D =4.5A	--	4.9	--	S
Dynamic Characteristics						
Input Capacitance	C _{iss}	V _{DS} =25V, V _{GS} =0V, f=1MHz	--	570	--	pF
Output Capacitance	C _{oss}		--	120	--	pF
Reverse Transfer Capacitance	C _{rss}		--	16	--	pF
Switching Characteristics						
Turn-on Delay Time	t _{d(on)}	V _{DD} =150V, I _D =9A V _{GS} =10V, R _G =25Ω	--	17	--	nS
Turn-on Rise Time	t _r		--	120	--	nS
Turn-off Delay Time	t _{d(off)}		--	28	--	nS
Turn-off Fall Time	t _f		--	49	--	nS
Total Gate Charge	Q _g	V _{DD} =150V, I _D =9A, V _{GS} =10V	--	15	--	nC
Gate-Source Charge	Q _{gs}		--	3.5	--	nC
Gate-Drain Charge	Q _{gd}		--	9	--	nC
Source-Drain Diode Characteristics						
Diode Forward Voltage ^{Note3}	V _{SD}	V _{GS} =0V, I _s =9A	--	--	1.5	V
Diode Forward Current ^{Note2}	I _s		--	--	9	A

Note: 1. Repetitive Rating: Pulse width limited by maximum junction temperature.

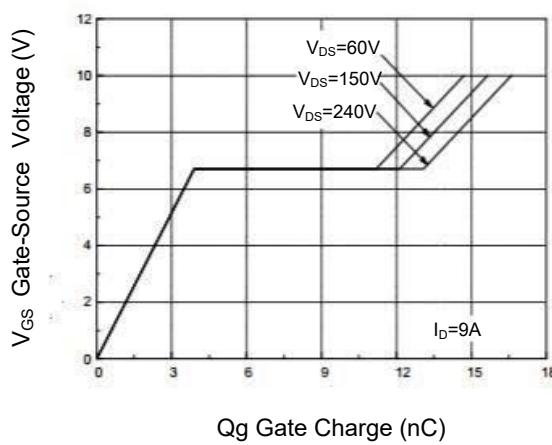
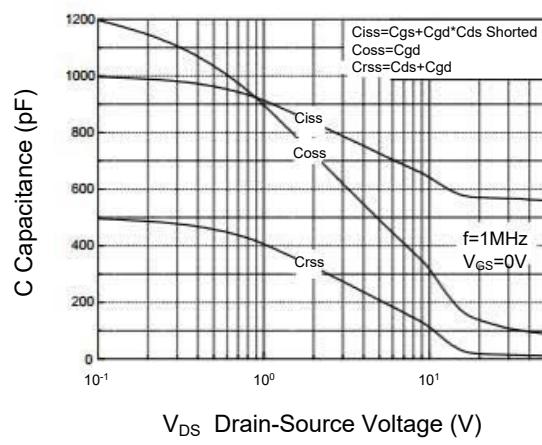
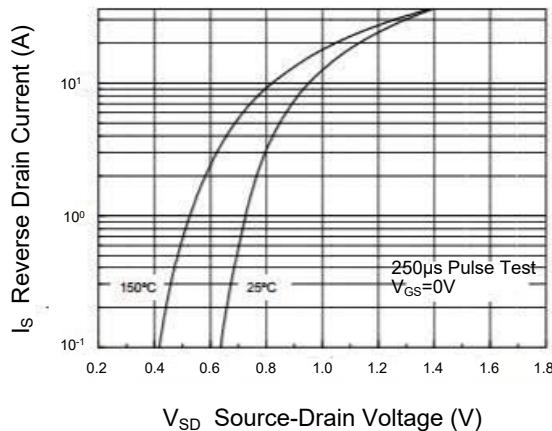
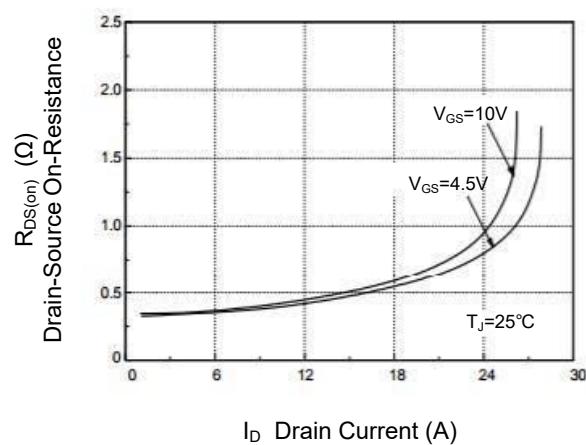
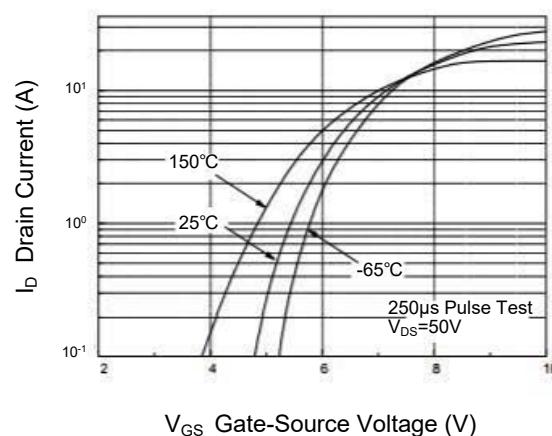
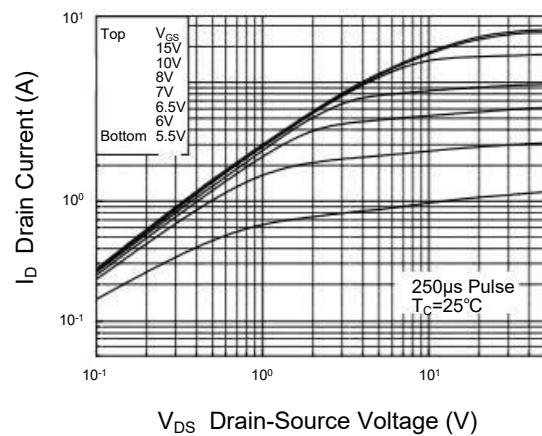
2. Surface Mounted on FR4 Board, t ≤ 10 sec.
3. Pulse Test: Pulse width≤380μs, duty cycle≤2%.
4. E_{AS} condition : L=10mH, I_D=9.5A, Start T_J=25°C.



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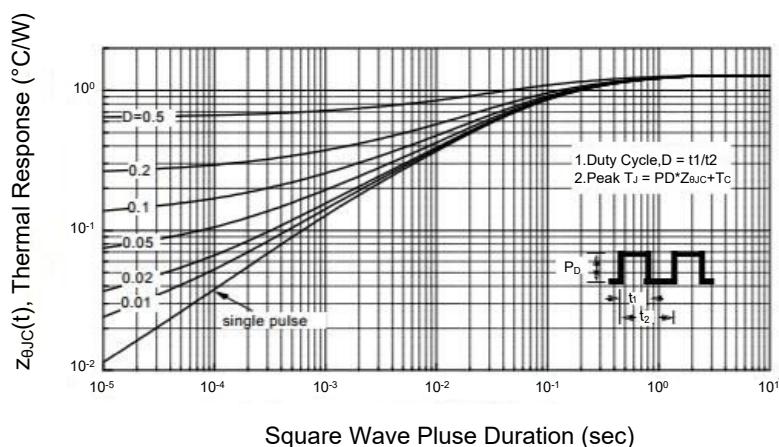
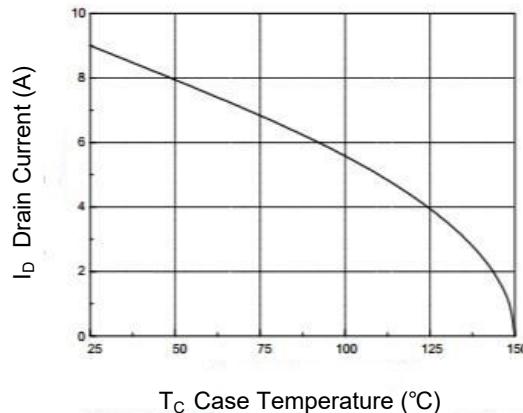
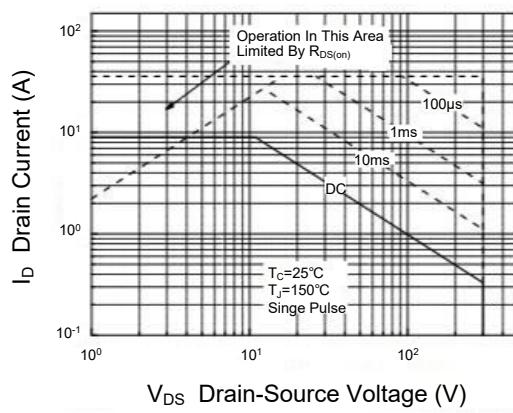
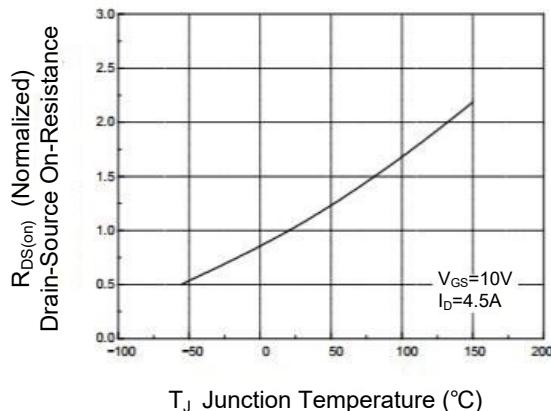
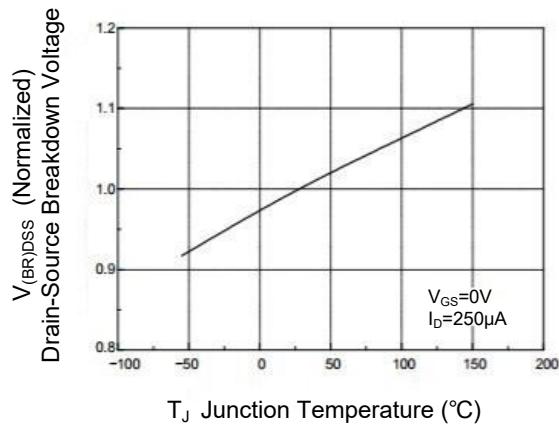
Typical Characteristic Curves





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Package Outline

TO-252

Dimensions in mm

